

IN THE CLAIMS:

*Sub C* ~~Claim 1 (previously presented): A capacitance type sensor comprising:  
a substrate;  
a group of fixed electrodes provided on an upper face of said substrate;  
a movable electrode plate having an electrode on a lower flat face thereof, said movable  
electrode plate having a rubber elasticity; and wherein~~

*B* ~~said substrate is provided with at least a solder layer having a thickness, in which said  
layer supports said movable electrode plate and said thickness of the layer provide a gap between  
said group of fixed electrodes on said substrate and said electrode on said movable electrode  
plate.~~

*B* ~~Claim 2 (currently amended): A capacitance type sensor comprising:  
a substrate;  
a group of fixed electrodes provided on an upper face of said substrate;  
a movable electrode plate having an electrode on a lower flat face thereof, said movable  
electrode plate having a rubber elasticity; and wherein~~

*B* ~~said substrate is provided with at least a layer of one of conductive elastomer, conductive  
paint and conductive adhesive material, said layer having a thickness in which said layer  
supports said movable electrode plate and said thickness of said layer provides a gap between  
said group of fixed electrodes on said substrate and said electrode on said movable electrode  
plate.~~

*B* ~~Claim 3 (original): A capacitance type sensor according to Claim 1, wherein said  
electrode on said movable electrode plate is made of one of conductive rubber plate and  
conductive elastomer plate.~~

*B* ~~Claim 4 (original): A capacitance type sensor according to Claim 2, wherein said  
electrode on said movable electrode plate is made of one of conductive rubber plate and  
conductive elastomer plate.~~